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TRANSMITTAL FORM (to be used for all correspondence after initial filing) Total Number of Pages in This Submission 11	Application Number Filing Date First Named Inventor Art Unit Examiner Name Attorney Docket Number	±10/757,586 01/15/04 R. Edwards 1753 Luan V. Van EI-2-04-001
ENCLOSURES (Check all that apply)		
Fee Attached Amendment/Reply After Final Affidavits/declaration(s) Extension of Time Request Express Abandonment Request Information Disclosure Statement Certified Copy of Priority Document(s) Reply to Missing Parts/ Incomplete Application Reply to Missing Parts under 37 CFR 1.52 or 1.53		ddress Status Letter Other Enclosure(s) (please Identify below):
SIGNATURE (OF APPLICANT, ATTOR	KNEY, OR AGENT
Himman, Howard & Kattell	1, LLP	
Signature Paus nee	l Finaley	
Printed name Lawrence R. Fraley		

CERTIFICATE OF TRANSMISSION/MAILING I hereby certify that this correspondence is being facsimile transmitted to the USPTO or deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on the date shown below: Signature Christine Lang Date 6/9/06

Reg. No.

26,885

Date

June 9, 2006

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BEFORE THE COMMISSIONER OF PATENTS

: 10/757,586

pplicant : Robert Edwards

Filed : 01/15/04

Art Unit : 1753

Examiner : Luan V. Van

Docket No. : EI-2-04-001

Title : Method of Making Printed Circuit Board With Electroplated Conductive

Thru Holes And Board Resulting Therefrom

Assignee : Endicott Interconnect Technologies, Inc.

Commissioner For Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

SECOND RESPONSE AFTER FINAL REJECTION

This is Applicant's second response, in view of the Notice of Non-Compliant Amendment dated 06/7/06. Please disregard Applicant's first response filed 04/25/06. Responsive to the Office Action dated 03/28/06, made final by the Examiner, please amend the above-identified application as follows. Entry is urged to allow Applicant the opportunity to respond to the new grounds of rejections raised in the 03/28/06 Action. Should the Examiner persist in the rejection, entry is urged to place the claims in better condition for appeal. Applicant respectfully submits, however, that the Application is in condition for allowance in view of the provided amending and supporting argumentation, and that further searching and/or other work on the part of the Examiner is not needed.

There are no Amendments to the Specification or Drawings since none are needed.

Amendments to the Claims begin on page 2 of this Response.

Remarks/Arguments begin on page 6 of this Response.

EI-2-04-001